imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

0603 Package Chip LED (0.2mm Height)

Features

- Package in 8mm tape on 7["] diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS

compliant version.

Descriptions

- The 19-219 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

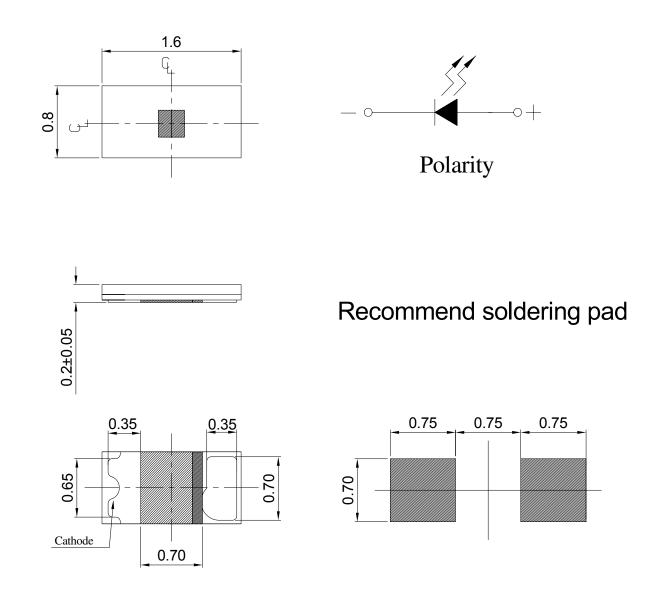
Part No.	Chip		Resin Color	
raft No.	Material	Emitted Color		
19-219/B6C-ZN1P2QY/3T	InGaN	Blue	Water Clear	



19-219/B6C-ZN1P2QY/3T



Package Outline Dimensions





Everlight Electronics Co., Ltd. Device No. : DSE-199-B01 http://www.everlight.com Prepared date: 05-Mar-2008

Parameter	Symbol	Rating	Unit		
Reverse Voltage	Vr	5	V		
Forward Current	IF	25	mA		
Peak Forward Current	I	100	A		
(Duty 1/10 @1KHz)	Ifp	100	mA		
Power Dissipation	Pd	95	mW		
Electrostatic Discharge(HBM)	ESD	150	V		
Operating Temperature	Topr	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
		Reflow Soldering : 260 $^{\circ}$ C for 10 sec.			
Soldering Temperature	Tsol	Hand Soldering : 350 $^{\circ}$ C for 3 sec.			

Absolute Maximum Ratings (Ta=25°C)

Electro-Optical Characteristics (Ta=25°C)

I				1		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	28.5		72.0	mcd	
Viewing Angle	2 <i>θ</i> 1/2		130		deg	
Peak Wavelength	λp		468		nm	
Dominant Wavelength	λd	465		475	nm	IF=5mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		25		nm	
Forward Voltage	VF	2.7		3.2	V	
Reverse Current	Ir			50	μA	VR=5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

19-219/B6C-ZN1P2QY/3T

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
	X 465 470	T 7 A				
	Y	470	475	nm	IF=5mA	

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
N1	28.5	36.0			
N2	36.0	45.0		T C A	
P1	45.0	57.0	- mcd	IF=5mA	
P2	57.0	72.0			

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
	29	2.7	2.8		
	30	2.8	2.9		
Q	31	2.9	3.0	V	IF=5mA
	32	3.0	3.1		
	33	3.1	3.2		

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength $\pm 1nm$

3.Tolerance of Forward Voltage $\pm 0.05V$

Forward Current vs. Spectrum Distribution Forward Voltage Ta=25°C Ta=25°C 100 50 Forward Current I_F (mA) Relative luminous intensity (%) 40 75 30 1 50 25 20 25 10 0 0 ₩ 2.6 400 450 500 550 600 3.0 3.4 4.5 3.8 4.2 Wavelength λ (nm) Forward Voltage $V_F(V)$ Luminous Intensity vs. Luminous Intensity vs. Forward Current Ta=25°C Ambient Temperature 1000 Relative luminous intensity (%) 1000 Relative luminous intensity (%) f=1KHz Duty=1/10 100 100 10 10 1 1 -60 -40 -20 0 20 40 60 80 100 10 10¹ 10 Forward Current I_{F} (mA) Ambient Temperature Ta (°C) Radiation Diagram Ta=25°C Forward Current Derating Curve 0° 10° 20° 50 30° Forward Current I_F (mA) 40 40° 30 1.0 25 0.9 50° 20 0.8 60° 10 70° 0.7 80° 00 90° 20 40 60 85 100 0.3 0.1 0.2 0.4 0.6 0.5 Ambient Temperature Ta (°C)

Typical Electro-Optical Characteristics Curves

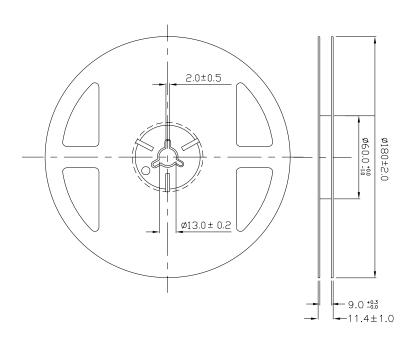
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Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



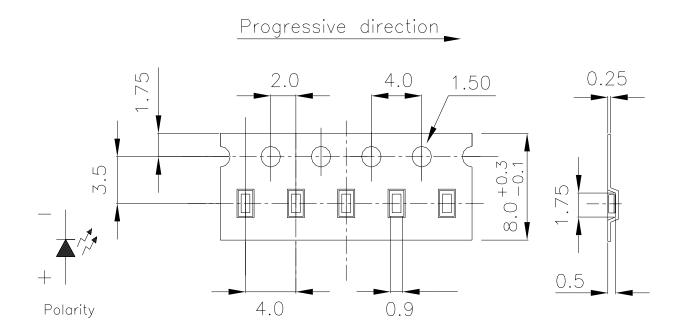
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

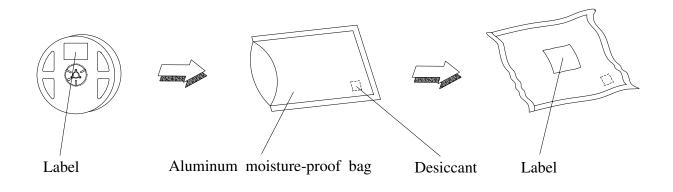
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Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

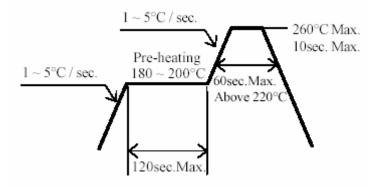
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min \int 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



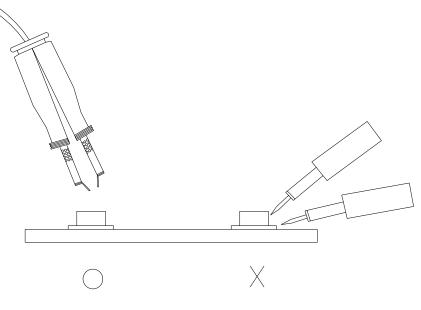
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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